



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT LED ORANGE, 0402 PACKAGE

BIVAR

SM0402OC

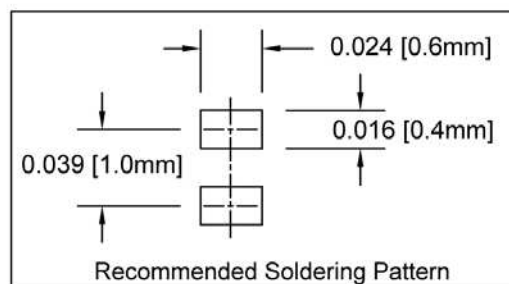
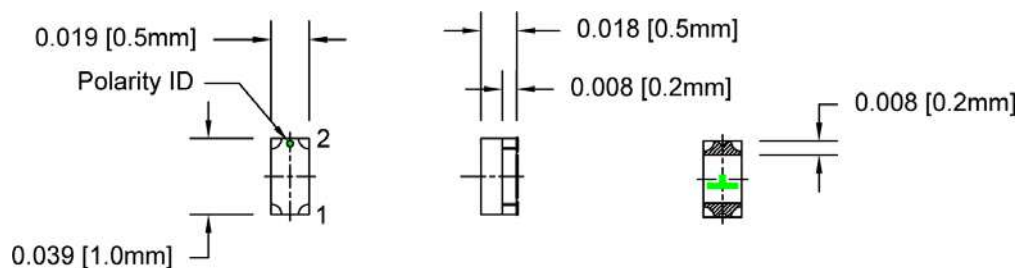
- ◆ Industry Standard 0402 Package
- ◆ RoHS Compliant
- ◆ Small Package and Footprint
- ◆ Water Clear Lens
- ◆ Wide Viewing Angle
- ◆ Ideal for Status Indication, Display, and Backlighting



Bivar Surface Mount 0402 package LED can be used in nearly any lighting or indication application. It's ultra-miniature packaging makes it ideal for smaller handheld devices, small back panel displays, and any other size constraint applications. Low power consumption and excellent long life reliability makes it excellent for battery powered equipment and applications. Bivar offers water clear LED lens for maximum luminous intensity. The SM0402 LED is packaged in standard tape and reels for pick and place assemblers.

Part Number	Material	Emitted Color	Peak Wavelength λ_p (nm) TYP.	Lens Appearance	Luminous Intensity (mcd) TYP.	Viewing Angle
SM0402OC	AlGaInP	ORANGE	610	Water Clear	145	130°

Outline Dimensions



Outline Drawings Notes:

1. All dimensions are in inches [millimeters].
2. Standard tolerance: ± 0.010 " unless otherwise noted.



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
SENSITIVE DEVICES



RoHS Compliant



Moisture
Sensitivity
Level 4

Bivar reserves the right to make changes at any time without notice.

SURFACE MOUNT LED ORANGE, 0402 PACKAGE



Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Power Dissipation	78 mW
Continuous Forward Current	30 mA
Peak Forward Current ¹	100 mA
Reverse Voltage	5 V
Derating Linear From 25°C	0.4 mA/°C
Electrostatic Discharge (HBM)	2000 V
Operating Temperature Range	-30 ~ +80°C
Storage Temperature Range	-40 ~ +85°C
Lead Soldering Temperature ²	260°C

Notes: 1. ≤ 10% Duty Cycle, Pulse Width ≤ 0.1 msec.

2. Solder time less than 5 seconds at temperature extreme.

Electrical / Optical Characteristics

T_A = 25°C & I_F = 20 mA unless otherwise noted

Part Number	Forward Voltage (V)			Recommend Forward Current (mA)			Reverse Current (μA)	Dominant Wavelength (nm)			Luminous Intensity I _v (mcd)			Viewing Angle 2Θ ½ (deg)
	MIN	TYP	MAX	MIN	TYP	MAX	MAX	MIN	TYP	MAX	MIN	TYP	MAX	TYP
SM0402OC	/	2.1	2.6	/	20	/	10	/	605	/	90	145	/	130

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SURFACE MOUNT LED ORANGE, 0402 PACKAGE



Typical Electrical / Optical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

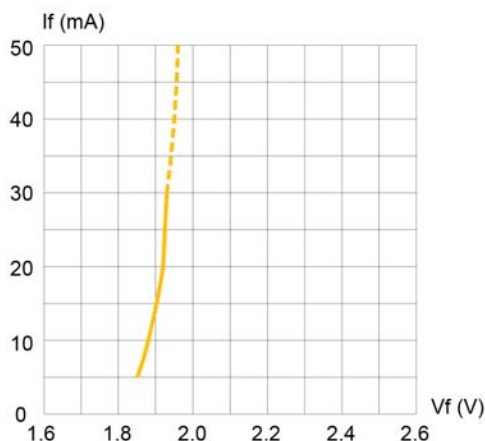


Fig. 1 Forward Current vs. Forward Voltage

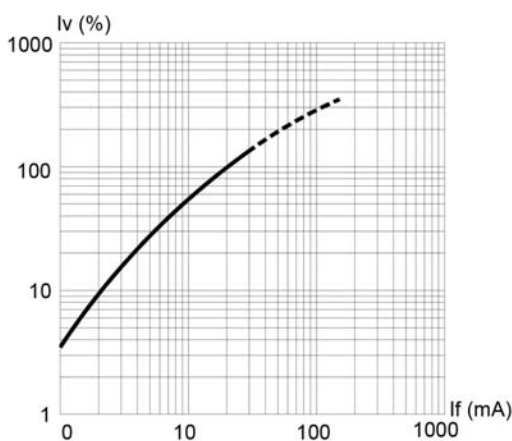


Fig. 2 Relative Luminous Intensity vs. Forward Current

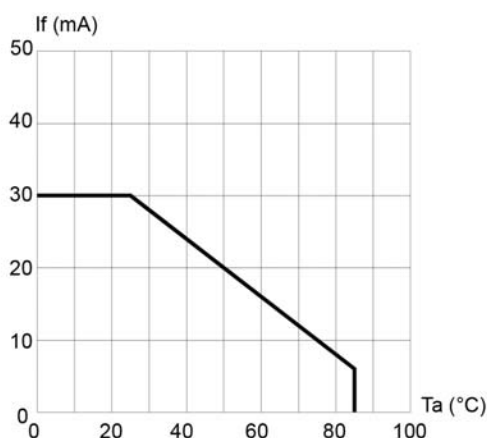


Fig. 3 Forward Current vs. Temperature

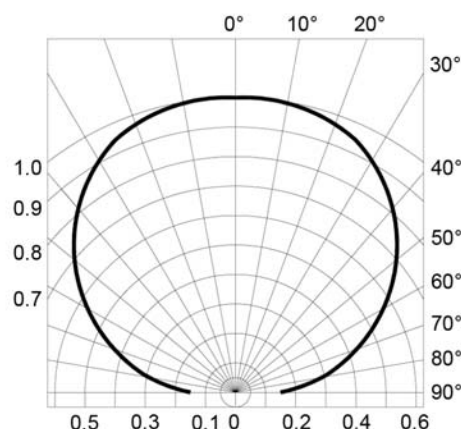


Fig. 4 Directivity Radiation Diagram

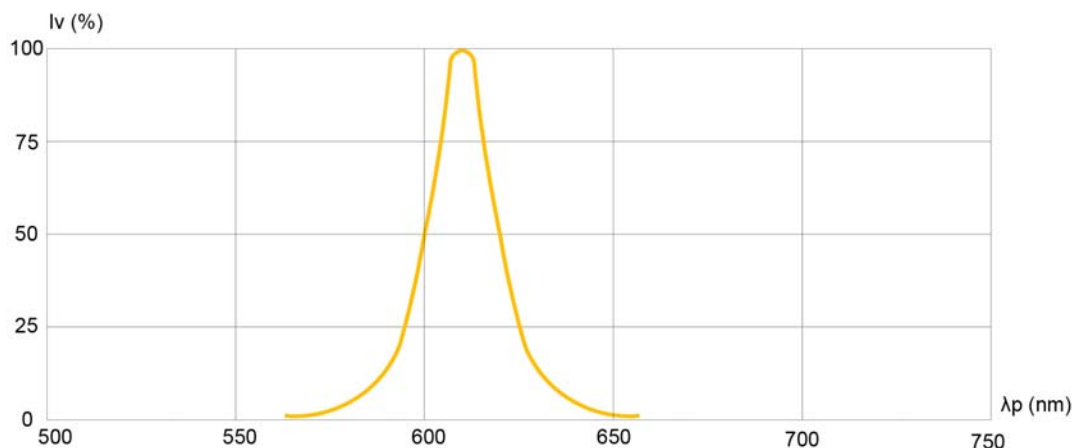


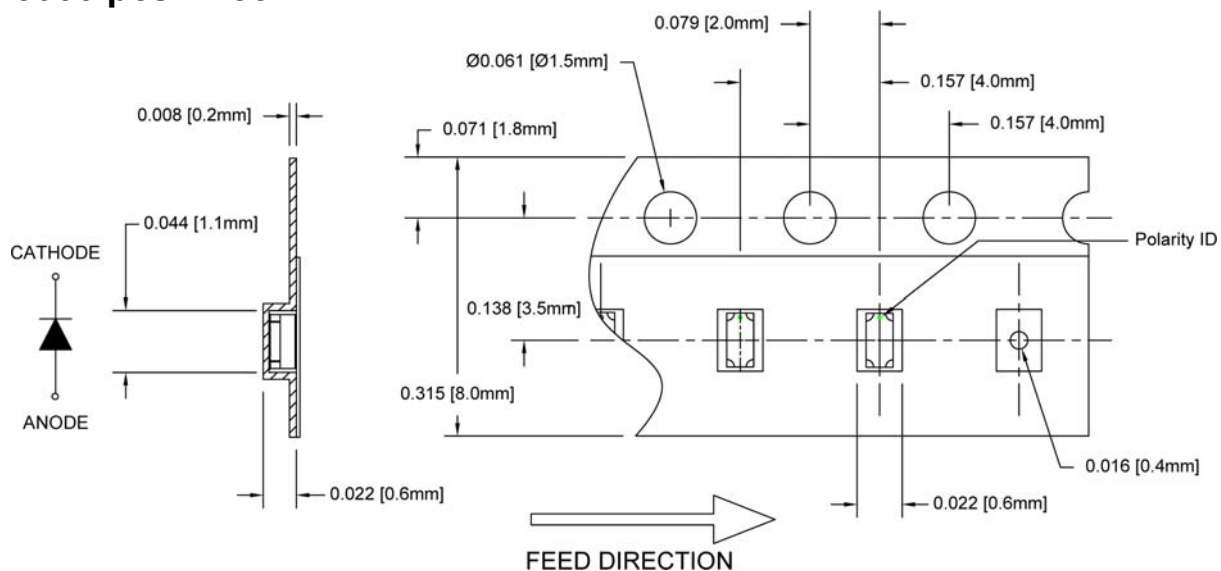
Fig. 5 Relative Luminous Intensity vs. Peak Wavelength

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The graph illustrates the temperature profile for a convective reflow soldering process. The y-axis represents temperature $T(^{\circ}\text{C})$ from 0 to 300, and the x-axis represents time $t(\text{sec.})$ from 0 to 400. The profile is divided into four stages: PREHEAT (0-100s), PREFLOW (100-200s), PREFLOW (200-300s), and COOLDOWN (300-400s). Two curves are shown: a blue curve for lead-free soldering and a red curve for leaded soldering. The lead-free curve peaks at 255°C, while the leaded curve peaks at 220°C. Both curves show a dwell at 170°C for 20-70 seconds above the liquidus. The graph also indicates a maximum lead-free soldering temperature of 255°C for 5 seconds and a maximum leaded soldering temperature of 220°C for 5 seconds.

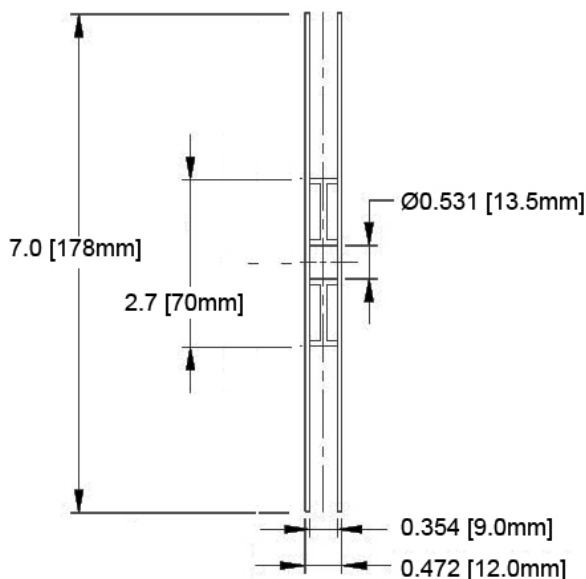
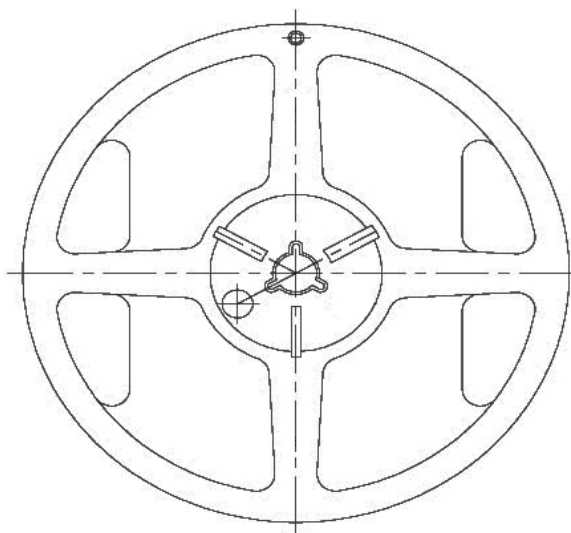
Time (sec.)	Lead-free Temp (°C)	Leaded Temp (°C)
0	25	25
25	100	100
50	150	150
75	170	170
100	170	170
125	170	170
150	170	170
175	170	170
200	180	180
225	200	200
250	230	210
275	250	220
300	255	220
325	200	200
350	150	150
375	120	120
400	100	100

Note: 5000 pcs / Reel



1. All dimensions are in inches [millimeters].
2. Standard tolerance: ± 0.010 " unless otherwise noted.

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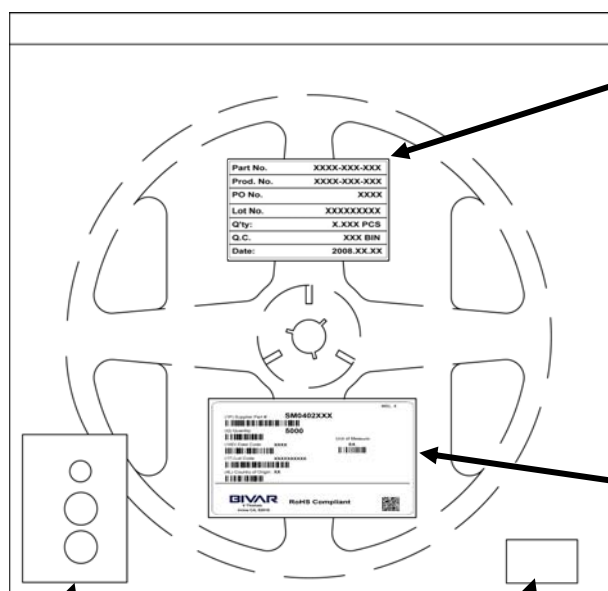
Outline Drawings Notes:

1. All dimensions are in inches [millimeters].
2. Standard tolerance unless otherwise noted: X.XXX $\pm$ 0.010"
X.X $\pm$ 0.1"

Packaging and Labeling Plan

Note: 1 Reel / Bag

Vacuum and Heat Sealed
ESD/MBB Bag



Part No.	XXXX-XXX-XXX
Prod. No.	XXXX-XXX-XXX
PO No.	XXXX
Lot No.	XXXXXXXXXX
Q'ty:	X.XXX PCS
Q.C.	XXX BIN
Date:	2008.XX.XX

Internal Quality Control Label



Bivar Standard Packaging Label

Humidity Indicator Card

Desiccant

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